



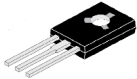
Continental Device India Pvt. Limited

An IATF 16949, ISO9001 and ISO 14001/ISO 45001 Certified Company



PNP PLASTIC POWER TRANSISTOR

CSB772P



TO-126

**TO-126 Leaded
Plastic Package
RoHS compliant**

FEATURES:

1. Complementary CSD882
2. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

APPLICATIONS: Audio Frequency Power Amplifier and Low Speed Switching

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	Value	UNIT
Collector -Base Voltage	V_{CBO}	40 (Min.)	V
Collector -Emitter Voltage	V_{CEO}	30 (Min.)	V
Emitter-Base Voltage	V_{EBO}	5 (Min.)	V
Collector Current Continuous	I_C	3 (Max.)	A
Collector Current (Pulse) ^{1.a}	I_C	7 (Max.)	A
Base Current (DC)	I_B	0.6 (Max.)	A
Total Power Dissipation@ Tc=25°C	P_{tot}	10 (Max.)	W
Total Power Dissipation@ Ta=25°C		1 (Max.)	W
Junction Temperature	$T_{j,}$	150 (Max.)	°C
Storage Temperature	T_{stg}	-65 to +150	°C

CSB772P

Rev01_ 12102022EM



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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$; unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	Min.	Typ.	Max.	UNIT
Collector-Cut off Current	I_{CBO}	$I_E = 0, V_{CB} = 30\text{V}$	--	--	1.0	μA
Emitter cut off Current	I_{EBO}	$V_{EB} = 3\text{V}, I_C = 0$	--	--	1.0	μA
Breakdown Voltages	V_{CEO}	$I_C = 1\text{mA}, I_B = 0$	30	--	--	V
	V_{CBO}	$I_C = 1\text{mA}, I_E = 0$	40	--	--	V
	V_{EBO}	$I_C = 0, I_E = 1\text{mA}$	5	--	--	V
Saturation Voltages	$V_{CE(sat)}^1$	$I_C = 2\text{A}, I_B = 0.2\text{A}$	--	--	0.5	V
	$V_{BE(sat)}^1$	$I_C = 2\text{A}, I_B = 0.2\text{A}$	--	--	2.0	V
DC Current Gain	h_{FE}^1	$I_C = 20\text{mA}, V_{CE} = 2\text{V}$	30	--	--	
		$I_C = 1.0\text{A}, V_{CE} = 2\text{V}^2$	60	--	400	
Output Capacitance at $f=1\text{MHz}$	C_O	$I_E = 0, V_{CB} = 10\text{V}$	--	55	--	pF
Transition Frequency	f_T	$I_C = 0.1\text{A}, V_{CE} = 5\text{V}$	--	80	--	MHz

Note:

1. Pulse test : pulse width $\leq 350\mu\text{s}$, Duty cycle $\leq 2\%$
 - 1.a. PW = 10ms, Duty Cycle $\leq 50\%$
2. hFE classification :

R :60-120	Q :100-200	P: 160-320	E: 200-400
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3. For PNP device voltage and current values will be negative (-).

CSB772P

Rev01_12102022EM

Recommended Reflow Solder Profiles

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.

Figure 1

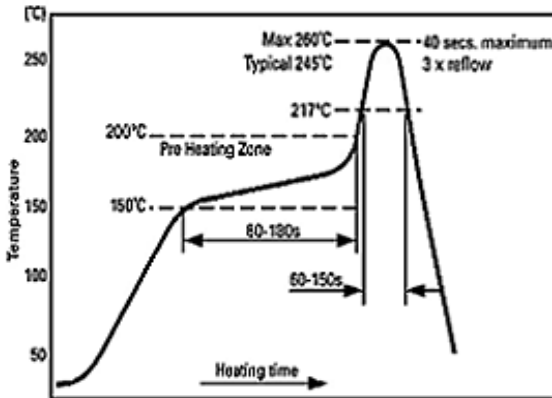
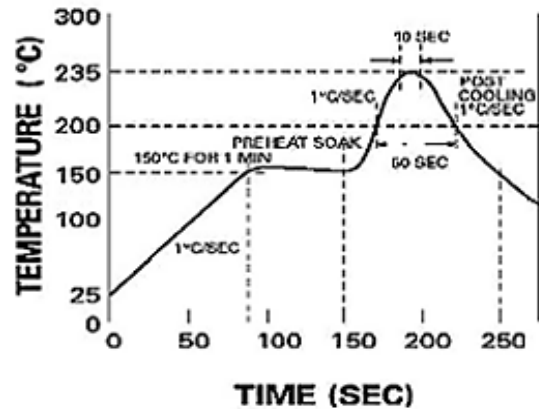


Figure 2

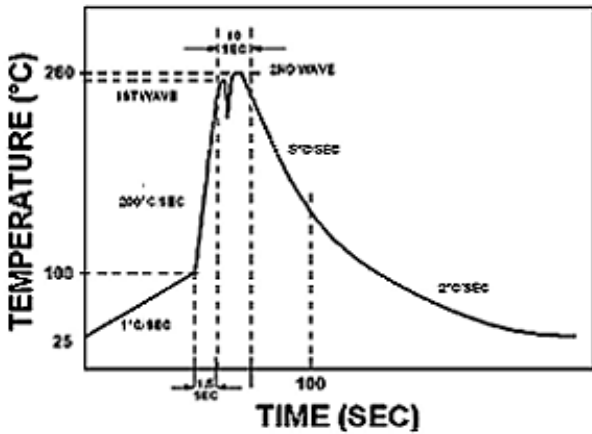


Reflow profiles in tabular form

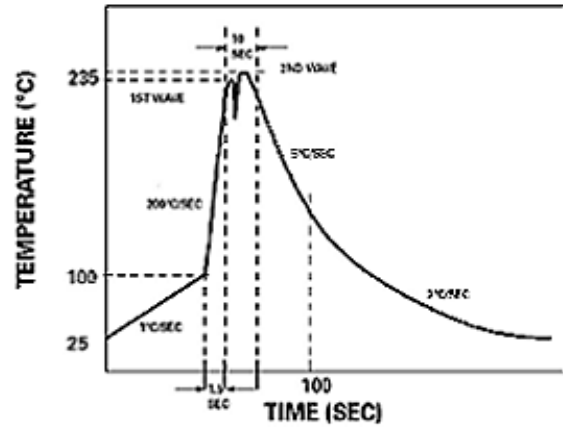
Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~3°C/second	~3°C/second
Preheat		
– Temperature Range	150-170°C	150-200°C
– Time	60-180 seconds	60-180 seconds
Time maintained above:		
– Temperature	200°C	217°C
– Time	30-50 seconds	60-150 seconds
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	40 seconds
Ramp-Down Rate	3°C/second max.	6°C/second max.

Recommended Wave Solder Profiles

The Recommended solder Profile For Devices with Pb-free terminal plating where a Pb-free solder is used



The Recommended solder Profile For Devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with leaded solder



Wave Profiles in Tabular Form

Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~200°C/second	~200°C/second
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	10 seconds
Ramp-Down Rate	5°C/second max.	5°C/second max

TYPICAL CHARACTERISTICS CURVE

Fig 1: Static Characteristic

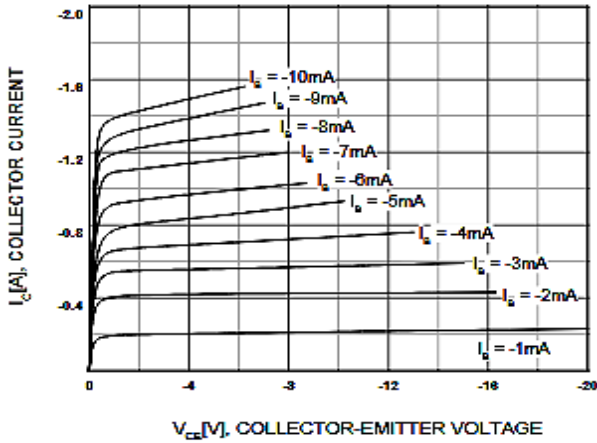


Fig 2: Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

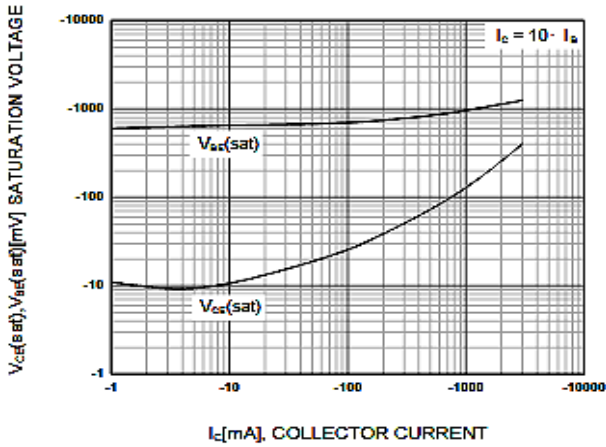


Fig 3: Current Gain Bandwidth Product

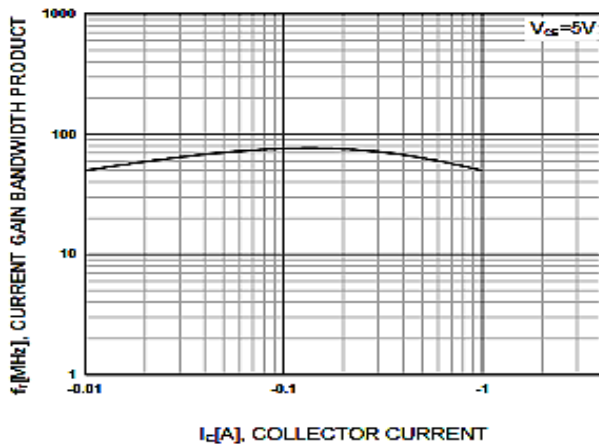


Fig 4: DC current Gain

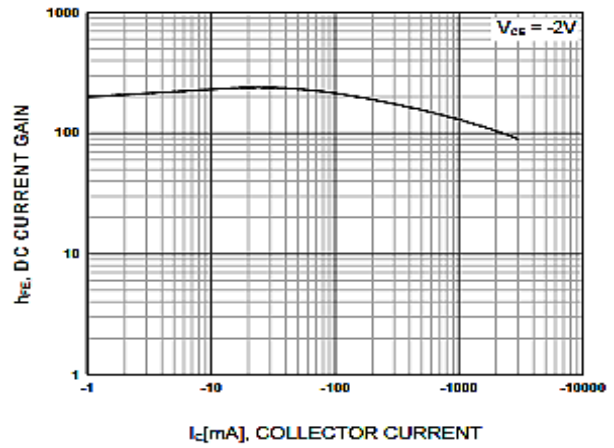


Fig 5: Collector Output Capacitance

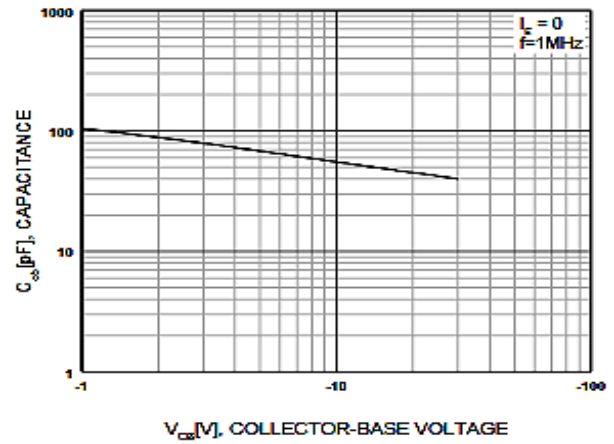
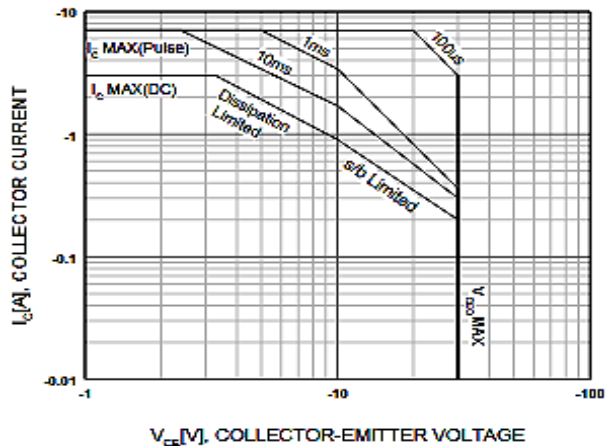


Fig 6: Safe Operating Area





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TYPICAL CHARACTERISTICS CURVE

Fig 7: Derating Curve of Safe Operating Areas

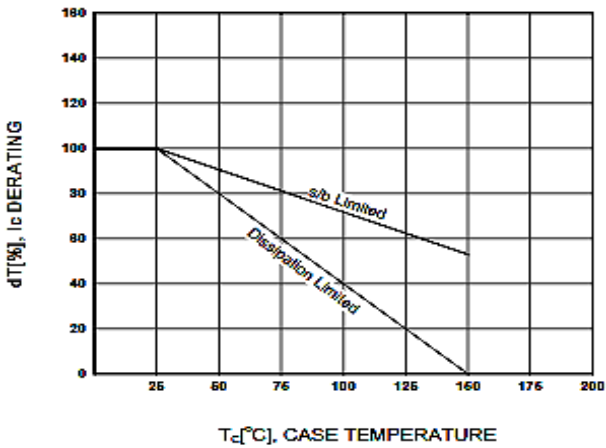
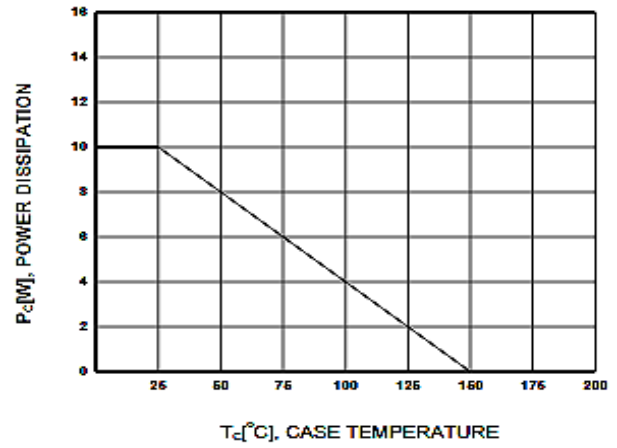


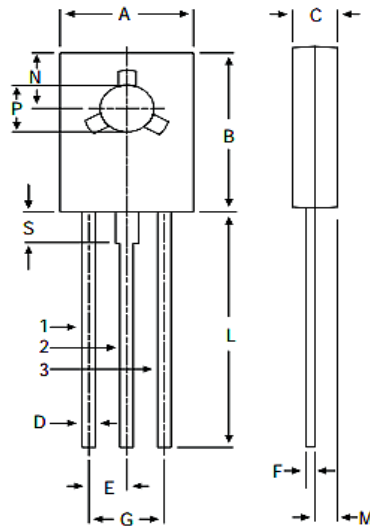
Fig 8: Power Derating



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Package Details

TO-126 Leaded Plastic Package

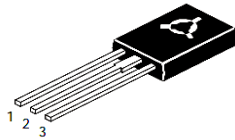


DIM	MIN	MAX
A	7.4	7.8
B	10.5	10.8
C	2.4	2.7
D	0.7	0.9
E	2.25 TYP	
F	0.49	0.75
G	4.5 TYP	
L	15.7 TYP	
M	1.27 TYP	
N	3.75 TYP	
P	3.0	3.2
S	2.5 TYP	

All dimensions in mm.

Pin Configurations

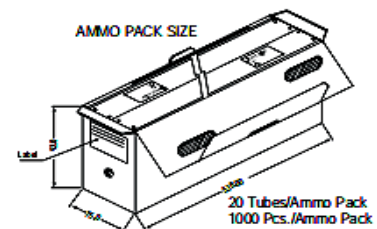
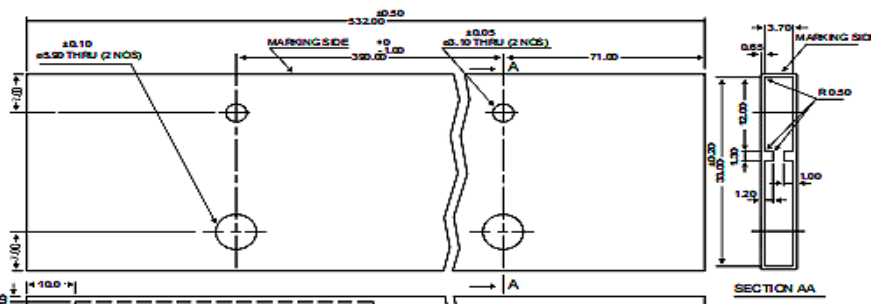
1. Emitter
2. Collector
3. Base



Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-126 Bulk	500 pcs/polybag	340 gm/500 pcs	3" x 7.5" x 7.5"	2K	17" x 15" x 13.5"	32K	31 kgs
TO-126 Tube	50 pcs/tube	73 gm/50 pcs	3" x 3.7" x 21.5"	1K	19" x 19" x 19"	10K	15 kgs

TO-126 TUBE PACKING



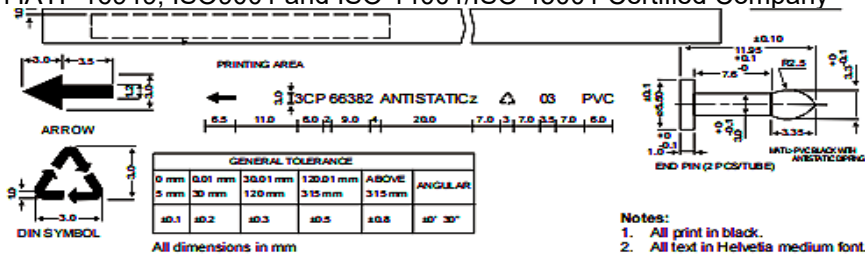
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Notes:
 1. All print in black.
 2. All text in Helvetica medium font.

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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- Air should be clean.
- Avoid harmful gas or dust.
- Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- Avoid condensation.
- Mechanical stress such as vibration and impact shall be avoided.
- The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level		
Level	Time	Condition
1	Unlimited	≤30 °C / 85% RH
2	1 Year	≤30 °C / 60% RH
2a	4 Weeks	≤30 °C / 60% RH
3	168 Hours	≤30 °C / 60% RH
4	72 Hours	≤30 °C / 60% RH
5	48 Hours	≤30 °C / 60% RH
5a	24 Hours	≤30 °C / 60% RH
6	Time on Label(TOL)	≤30 °C / 60% RH

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Customer Notes

Component Disposal Instructions

1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the Coil's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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Rev01_ 12102022EM